Integrated Device Technology, Inc. 6024 Silver Creek Valley Road, San Jose, CA - 95138 PRODUCT/PROCESS CHANGE NOTICE (PCN) PCN #: F0509-01 Date: 10/18/2005 Product Affected: IDT72255LA, IDT72265LA, IDT72265LA, IDT72265LA, IDT72265LA, IDT72V255LA MEANS OF DISTINGUISHING CHANGED DEVICES: Product Affected: IDT72271LA, IDT72V255LA MEANS OF DISTINGUISHING CHANGED DEVICES: Date Effective: 1/18/2006 Date Code Devices with Date Code >=0606	
Contact:Lakshmi SrinivasanTitle:Quality EngineerPhone #:(408) 284-4580Fax #:(408) 284-1450E-mail:Lakshmi.Srinivasan@idt.com	Attachment: Yes No Samples: Available on request
DESCRIPTION AND PURPOSE OF CHANGE: Die Technology Wafer Fabrication Process Add Skew time (tSKEW4) between the read and write clocks for re-transmit Assembly Process operation only. This is to improve speed distribution for faster speed grade Equipment products. Material Testing Manufacturing Site Jata Sheet Other Other	
RELIABILITY/QUALIFICATION SUMMARY: This change has no impact on the Quality or Reliability of the product.	
CUSTOMER ACKNOWLEDGMENT OF RECEIPT: IDT records indicate that you require written notification of this change. Please use the acknowledgement below or E-Mail to grant approval or request additional information. If IDT does not receive acknowledgement within 30 days of this notice it will be assumed that this change is acceptable. IDT reserves the right to ship either version manufactured after the process change effective date until the inventory on the earlier version has been depleted.	
Customer:	□ Approval for shipments prior to effective date.
Name/Date:	E-Mail Address:
Title:	Phone# /Fax# :
CUSTOMER COMMENTS:	
IDT ACKNOWLEDGMENT OF RECEIPT:	
RECD. BY:	DATE: